

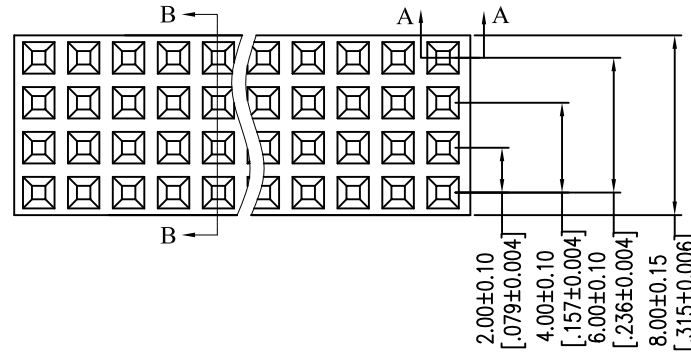
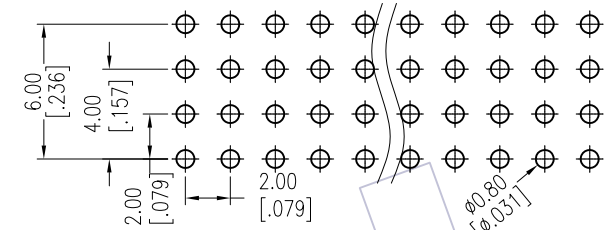
HSF

NOTES:
 Current Rating: 2.0AMP
 Contact Resistance: 20mΩ Max
 Withstand Voltage: 500V AC/DC
 Insulation Resistance: 1000MΩ Min
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze
 Contact plating: Au Or Sn over Ni
 Insulator Material: LCP+30%G.F UL94V-0



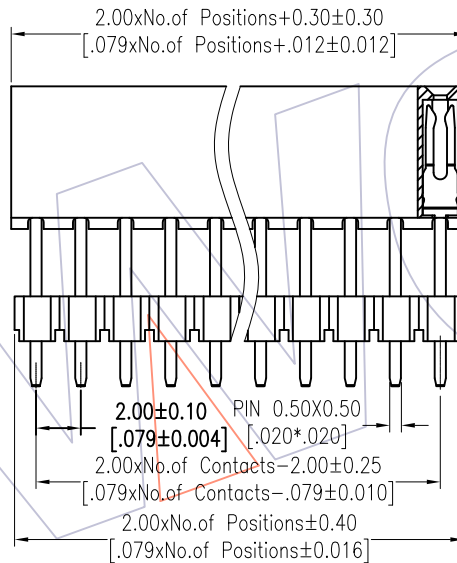
Recommended P.C.B Layout (Top Side)
 (PCB BOARD TOLERANCE ±0.05)



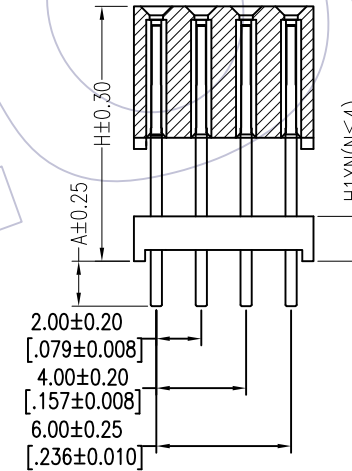
Ordering Information

2263D - 4 XX S XX DYN X X

No. of Pins per ROW: 02-40PIN
 Contact Plating:
 G0=Gold Flash
 G3=10μ"Gold
 G4=15μ"Gold
 G5=30μ"Gold
 S0=Gold Flash/Tin
 S3=10μ"Gold/Tin
 S4=15μ"Gold/Tin
 S5=30μ"Gold/Tin
 SN=Tin
 SM=Matte Tin
 Insulator: D=LCP
 Packing: T=Tube A=Tray



SECTION A-A



SECTION B-B

Item	Pitch	Mating
Standard	2.00	1215/1220
Alternate		

DIMENSION ANTITHESSES LIST			
H1XN(N≤4)	A	H	H1
STANDARD	2.28	9.35	1.50
ALTERNATE			

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
				x.x ±0.40	Wang	2013/04/26	UNIT	mm	2263D-4XXSXXDYNXX
A1	2013/04/26	Modify drawing	-----	x.xx ±0.25	CHECK	DATE	SIZE	A4	
AO	2012/12/07	NEW	-----	x.xxx ±0.15	APPROVE	DATE	SHEET	1/1	TITLE: FH2.00mm FOUR ROW 180° DIP H=6.35+HOUSING
				Angle ± 3'			PROJ.	Customer NO.	